WINSTAR Display

OLED SPECIFICATION

Model No:

WEO012864MXPP3N00001

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RELEASE DATE:

MODULE NO.: WEO012864MXPP3N00001

APPROVED BY:
FOR CUSTOMER USE ONLY)

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

PAPPROVAL FOR SPECIFICATIONS ONLY

APPROVAL FOR SPECIFICATIONS AND SAMPLE

MODEL NO:

RECORDS OF REVISION			DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2017/07/31		First release
А	2018/11/30		Modify Static electricity test Content of Test
В	2019/03/27		SAMPLE SPEC
С	2019/09/02		Modify Precautions in use of OLED Modules
D	2019/12/18		Modify Reliability Test measurement conditions & Inspection specification:" Accept no dense" modify to "ignore"& Precautions
E	2020/05/07		Modify Application recommendations & Absolute Maximum Ratings & DC Electrical Characteristics & Initial code

Contents

- 1. Module Classification Information
- 2.General Specification
- 3. Contour Drawing & Block Diagram
- 4.Interface Pin Function
- 5. Absolute Maximum Ratings
- 6. Electrical Characteristics
- 7. Optical Characteristics
- 8.OLED Lifetime
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules

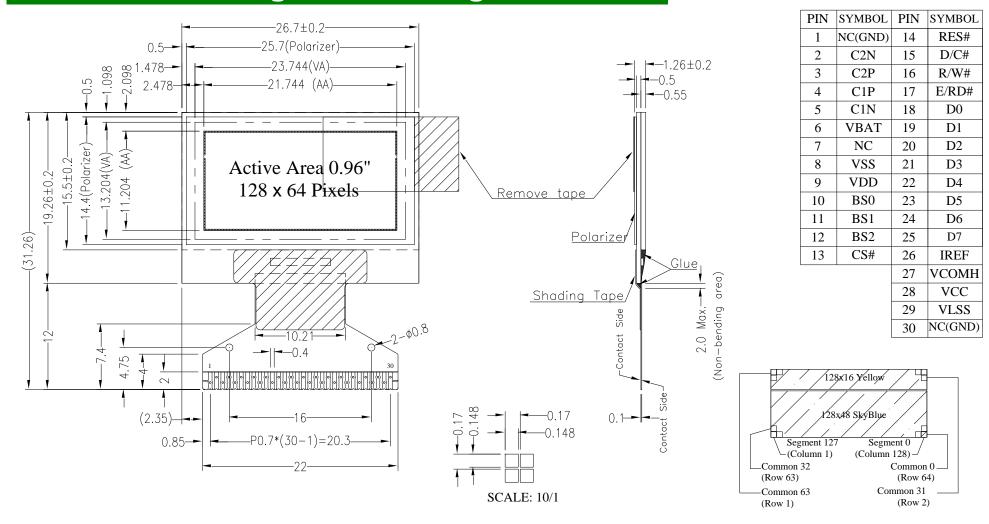
1.Module Classification Information

A	1	Brand: WINSTAR DISPLAY CORPORATION							
Display Type	2	E: OLED							
Display Type P: COG + FR + PCB X: TAB A: COG + PCB B: Blue W: White G: Green L: Yellow S: Sky Blue X: Dual Color P: With Polarizer; N: Without Polarizer A: Anti-glare Polarizer A: Ant			H: COB Character	G: COB Graphic					
P : COG + FR + PCB		Diamles Time	O: COG	F: COG + FR					
4 Dot Matrix: 128 * 64 5 Serials code A : Amber	3	Display Type	P: COG + FR + PCB	X: TAB					
5 Serials code A : Amber R : Red C : Full Color			A: COG + PCB						
A: Amber R: Red C: Full Color B: Blue W: White G: Green L: Yellow S: Sky Blue X: Dual Color P: With Polarizer; N: Without Polarizer A: Anti-glare Polarizer Bisplay Mode P: Passive Matrix; N: Active Matrix Priver Voltage 3: 3.0~3.3V; 5: 5.0V N: Without touch panel; T: With touch panel Product type 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting O: Standard 1: Daylight Readable 2: Special grade C: Automotive grade	4	Dot Matrix: 12	28 * 64						
B: Blue W: White G: Green L: Yellow S: Sky Blue X: Dual Color Polarizer Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: With Polarizer; N: Without Polarizer Biglue Display Mode P: Without Polarizer	5	Serials code							
6 Emitting Color G: Green S: Sky Blue X: Dual Color P: With Polarizer; N: Without Polarizer A: Anti-glare Polarizer 8 Display Mode P: Passive Matrix; N: Active Matrix 9 Driver Voltage 3: 3.0~3.3V; 5: 5.0V 10 Touch Panel N: Without touch panel; T: With touch panel 0: Standard 1: Daylight Readable 11 Product type 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 1: Dayloghting 0: Standard C: Special grade C: Automotive grade			A: Amber	R: Red	C : Full Color				
G: Green L: Yellow S: Sky Blue X: Dual Color Polarizer Polarizer; N: Without Polarizer A: Anti-glare Polarizer Bisplay Mode P: Passive Matrix; N: Active Matrix Diriver Voltage 3: 3.0~3.3V; 5: 5.0V Driver Voltage N: Without touch panel; T: With touch panel O: Standard 1: Daylight Readable 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting O: Standard D: Standard C: Special grade C: Automotive grade		Emitting Color	B: Blue	W: White					
P: With Polarizer; N: Without Polarizer A: Anti-glare Polarizer B Display Mode P: Passive Matrix; N: Active Matrix Driver Voltage 3: 3.0~3.3V; 5: 5.0V Touch Panel N: Without touch panel; T: With touch panel C: Standard 1: Daylight Readable 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: Special grade C: Automotive grade	0		G: Green	L: Yellow					
A : Anti-glare Polarizer 8 Display Mode P : Passive Matrix ; N : Active Matrix 9 Driver Voltage 3 : 3.0~3.3V ; 5 : 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting 0 : Standard 2 : Special grade C : Automotive grade			S: Sky Blue	S: Sky Blue X: Dual Color					
A : Anti-glare Polarizer 8 Display Mode P : Passive Matrix ; N : Active Matrix 9 Driver Voltage 3 : 3.0~3.3V ; 5 : 5.0V 10 Touch Panel N : Without touch panel; T: With touch panel 0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting 0 : Standard 2 : Special grade C : Automotive grade	7	Polarizer		·					
9 Driver Voltage 3:3.0~3.3V; 5:5.0V 10 Touch Panel N: Without touch panel; T: With touch panel 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: Special grade C: Automotive grade									
10 Touch Panel N: Without touch panel; T: With touch panel 0: Standard 1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: Special grade Grade C: Automotive grade			·						
0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting 0 : Standard 2 : Special grade C : Automotive grade			,						
1: Daylight Readable 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: Special grade C: Automotive grade	10	Touch Panel	-	N: Without touch panel; T: With touch panel					
11 Product type 2: Transparent OLED (TOLED) 3: Flexible OLED (FOLED) 4: OLED Lighting 0: Standard 2: Special grade C: Automotive grade									
3 : Flexible OLED (FOLED) 4 : OLED Lighting 0 : Standard 2 : Special grade C : Automotive grade			, ,	(=0, ==)					
4 : OLED Lighting 0 : Standard 2 : Special grade C : Automotive grade	11	Product type	-	,					
12 Inspection Grade C: Automotive grade 0: Standard 2: Special grade C: Automotive grade			,						
12 Inspection 2 : Special grade C : Automotive grade									
Grade C : Automotive grade		Increation							
g and g	12	•							
The state of the s		Y : Consumer grade							
13 Option 0 : Default ; F : ZIF FPC ; H : Hot bar FPC; D : Demo Kit	13	Option	-						
14 Serial No. Serial number(00~ZZ)	14	+ •	Serial number(00~ZZ)						

2.General Specification

Item	Dimension	Unit			
Dot Matrix	128 x 64 Dots	_			
Module dimension	26.7× 19.26 × 1.26	mm			
Active Area	21.744× 11.204	mm			
Pixel Size	0.148 × 0.148	mm			
Pixel Pitch	0.17 × 0.17	mm			
Display Mode	Passive Matrix				
Display Color	Yellow / Sky Blue				
Drive Duty	1/64 Duty				
IC	SSD1306				
Interface	6800,8080,SPI,I2C				
Size	0.96 inch				

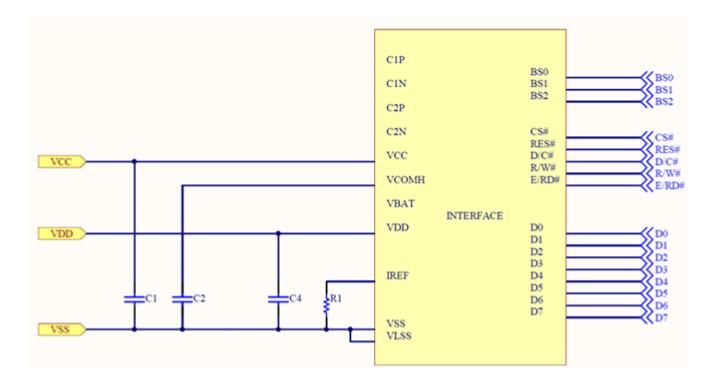
3. Contour Drawing & Block Diagram



The non-specified tolerance of dimension is ± 0.3 mm.

3.1 Application recommendations

External VCC Solution



Recommended components:

C1, C2: 2.2uF

C4: 1.0uF

Bus Interface selection: (Must be set the BS[2:0], refer to Section 4)

 $8\mbox{-bits}$ 6800 and 8080 parallel, 3 or 4-wire SPI, I2C

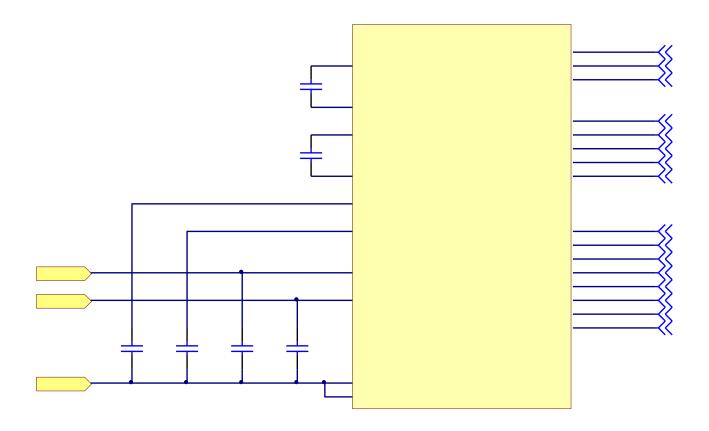
Voltage at IREF = VCC - 3V. For VCC = 12V, IREF = 30uA:

R1 = (Voltage at IREF - VSS) / IREF

= (12-3)V / 30uA

= 300 K ohm

Built-in DC-DC Solution



Recommended components:

C1, C2: 2.2uF C3, C4: 1.0uF

C5, C6: 1.0uF/10V

Bus Interface selection: (Must be set the BS[2:0], refer to item 4)

8-bits 6800 and 8080 parallel, 3 or 4-wire SPI, I2C

IREF should be left open.

4. Interface Pin Function

No.	Symbol	Function					
	_	Reserved Pin (Supporting Pin)					
1	N.C.	The supporting pins can reduce the influences from stresses on the					
	(GND)	function pins. These pins must be connected to external ground.					
2	C2N	Positive Terminal of the Flying Inverting Capacitor Negative Terminal of					
3	C2P	the Flying Boost Capacitor The charge-pump capacitors are required					
4	C1P	between the terminals. They must be floated when the converter is not					
5	C1N	used.					
		Power Supply for DC/DC Converter Circuit					
6	VBAT	This is the power supply pin for the internal buffer of the DC/DC voltage					
6	VDAI	converter. It must be connected to external source when the converter is					
		used. It should be connected to VDD when the converter is not used.					
7	NC	NC					
		Ground of Logic Circuit					
8	VSS	This is a ground pin. It acts as a reference for the logic pins. It must be					
		connected to external ground.					
9	VDD	Power Supply for Logic					
		This is a voltage supply pin. It must be connected to external source.					
10	DCO	Communicating Protocol Select					
10	BS0	These pins are MCU interface selection input. See the					
		following table:					
11	BS1	BS0 BS1 BS2 I2C					
''		3-wire SPI 1 0 0					
		4-wire SPI 0 0 0					
12	BS2	8-bit 68XX Parallel 0 0 1					
		8-bit 80XX Parallel 0 1 1					
		Chip Select					
13	CS#	This pin is the chip select input. The chip is enabled for MCU					
		communication only when CS# is pulled low.					
4.4	DEC."	Power Reset for Controller and Driver					
14	KES#	This pin is reset signal input. When the pin is low, initialization of the chip					
		is executed.					
		Data/Command Control					
		This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data.					
		When the pin is pulled low, the input at D7~D0 will be transferred to the					
		command register. For detail relationship to MCU interface signals,					
15	D/C#	please refer to the Timing Characteristics Diagrams.					
		When the pin is pulled high and serial interface mode is selected, the					
		data at SDIN is treated as data. When it is pulled low, the data at SDIN					
		will be transferred to the command register. In I2C mode, this pin acts as					
		SA0 for slave address selection.					
L	1						

16	R/W#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
17	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
18~25	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
26	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 30uA.
27	VCOMH	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
28	VCC	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and VSS when the converter is used. It must be connected to external source when the converter is not used.
29	VLSS	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally.
30	NC (GND)	Reserved Pin (Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.

5.Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	0	4	V	1,2
Charge Pump Regulator Supply Voltage	VBAT	-0.3	5.0	V	1,2
Supply Voltage for Display	VCC	0	16.0	V	1,2
Operating Temperature	TOP	-40	+80	°C	_
Storage Temperature	TSTG	-40	+85	°C	_

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6. "Optics & Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

6.Electrical Characteristics

6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage for Logic	VDD	_	2.8	3.0	3.3	V
Supply Voltage for Display (Supplied Externally)	VCC	_	11.5	12	12.5	V
Charge Pump Regulator Supply Voltage	VBAT	_	3.0	_	4.2	V
Charge Pump Output Voltage for Display (Generated by Internal DC/DC)	Charge Pump VCC	_	7.0	7.5	_	V
Input High Volt.	VIH	_	0.8×VDD	_	VDD	V
Input Low Volt.	VIL	_	0	_	0.2×VDD	V
Output High Volt.	VOH	_	0.9×VDD	_	VDD	V
Output Low Volt.	VOL	_	0	_	0.1×VDD	V
Operating Current for VCC (50% display ON) (VCC Supplied Externally)	ICC	VCC =12V	-	9	13.5	mA
50% check Board operating Current (VCC Generated by Internal DC/DC)	IBAT	_	_	15	25	mA

6.2 Initial code

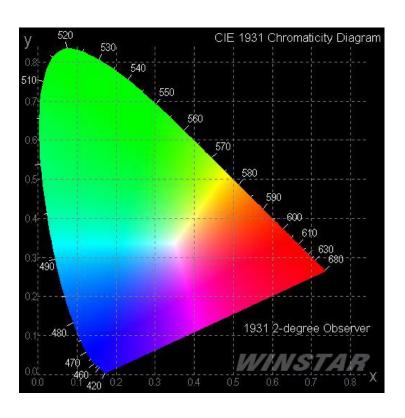
void Initial IC(){

```
Write command(0xAE); // Display Off
                       //SET DISPLAY CLOCK
Write_command(0xD5);
Write_command(0x80);
                      //105HZ
                       //Select Multiplex Ratio
Write command(0xA8);
Write command(0x3F);
                      //Default => 0x3F (1/64 Duty)
Write command(0xD3);
                       //Setting Display Offset
Write_command(0x00);
                      //00H Reset
Write command(0x40);
                      //Set Display Start Line
Write command(0x8D);
                       //Set Charge Pump
Write command(0x10):
                      //Disable Charge Pump
//Write command(0x14); //Enable Charge Pump
Write command(0xAD);
                       //Internal IREF Setting
Write command(0x20);
                       //Disable internal IREF
//Write command(0x30); //Enable internal IREF
Write_command(0xA1); //Set Segment Re-Map Default
Write command(0xC8); //Set COM Output Scan Direction
Write command(0xDA);
                       //Set COM Hardware Configuration
Write_command(0x12); //Alternative COM Pin
Write command(0x81); //Set Contrast Control
Write command(0xAF):
Write_command(0xD9); //Set Pre-Charge period
Write_command(0x22);
Write_command(0xDB); //Set Deselect Vcomh level
Write command(0x30);
Write command(0xA4): //Entire Display ON
Write_command(0xA6); //Set Normal Display
Write command(0xAF); // Display ON
```

}

7.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angele	(V)θ		160			deg
View Angle	(Η)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	
Deep and a Time	T rise	_		10		μs
Response Time	T fall	_		10		μs
Display with 50% check Board Brightness			60	80		cd/m2
CIEx(Yellow)	(CIE1931)	0.45	0.47	0.49		
CIEy(Yellow)	(CIE1931)	0.48	0.50	0.52		
CIEx(SkyBlue)	(CIE1931)	0.12	0.16	0.20		
CIEy(SkyBlue)	(CIE1931)	0.22	0.26	0.30		



8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25°C / Initial 50% check board brightness Typical Value	20,000 Hrs	-	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.

9.Reliability

Content of Reliability Test

Environmenta	Il Test	T	Amml's st.
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	85°C 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40°C 240hrs	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80°C 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40°C 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C,90%RH 240hrs	
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C,90%RH 120hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -40°C 25°C 80°C 30min 5min 30min 1 cycle	-40°C /80°C 30 cycles	
Mechanical Te	st		
Vibration test Endurance test applying the vibration during transportation and using.		Frequency:10~55Hz amplitude:1.5mm Time:0.5hrs/axis Test axis:X,Y,Z	
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv,10 times	

^{***} Supply voltage for OLED system =Operating voltage at 25°C

Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels on/off exchange is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

10.Inspection specification

Inspection Standard:

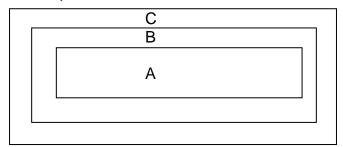
MIL-STD-105E table normal inspection single sample level II.

Definition

1 Major defect: The defect that greatly affect the usability of product.

2 Minor defect: The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

Inspection Methods

- 1 The general inspection: Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.
- 2 The luminance and color coordinate inspection: By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion	AQL
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 	0.65
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm. 	2.5

NO	Item	Criterion				AQL	
	OLED black spots, white spots, contaminati on (non-display)	3.1 Round typ As following drawing Φ=(x+y)/2	(SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable QTY ignore 2 1 0	Zone A+ B, A+ B A+ B	2.5
03		Le Le	ength ≤3.0 ≤2.5	Width W≤0.02 0.02 <w≤0.0 0.03<w≤0.0="" 0.05<w<="" td=""><td>Acceptable Q TY ignore 3</td><td>Zone A+B A+B A+B</td><td>2.5</td></w≤0.0>	Acceptable Q TY ignore 3	Zone A+B A+B A+B	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black sp specifications, not easy to fin must check in specify direction.	oot 0 dd, 1	Size Φ $0 \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $0.00 < \Phi$ Total Q TY	Acceptable Q TY ignore 3 2 0 3	Zone A+B A+B A+B A+B	2.5
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.					

NO	Item	Criterion		
06	Chipped glass	Symbols Define: x: Chip length	2.5	
		z: Chip thickness y: Chip width x: Chip length $Z \le 1/2t$ Not over viewing area $x \le 1/8a$ $1/2t < z \le 2t$ Not exceed $1/3k$ $x \le 1/8a$ $Old If there are 2 or more chips, x is the total length of each chip.$		
06	Glass crack	Symbols: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:		
		$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$		

NO	Item	Criterion		
06	Glass crack	6.2.2 Non-conductive portion: Variable Variable	2.5	
07	Cracked glass	The OLED with extensive crack is not acceptable.		
08	Backlight elements	8.1 Illumination source flickers when lit.8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards.		
		8.3 Backlight doesn't light or color wrong.	0.65	
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.	2.5	
		9.2 Bezel must comply with job specifications.10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	0.65 2.5	
	PCB , COB	10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram.	2.5 0.65	
		10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.	2.5	
10		10.5 No oxidation or contamination PCB terminals.	2.5	
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.	0.65	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65	
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5	

NO	Item	Criterion	
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Pixel C Light Pixel

11.Precautions in use of OLED Modules

Modules

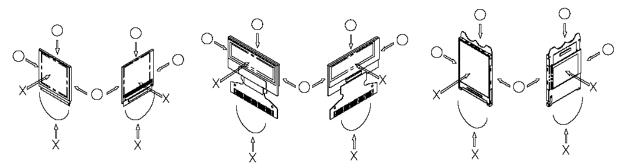
- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Winstar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) Winstar has the right to upgrade or modify the product function.

11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
 - * Scotch Mending Tape No. 810 or an equivalent
 - Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

Also, pay attention that the following liquid and solvent may spoil the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
 - * Pins and electrodes
 - * Pattern layouts such as the TCP & FPC
- (8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
 - * Be sure to make human body grounding when handling OLED display modules.
 - * Be sure to ground tools to use or assembly such as soldering irons.
 - * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
 - * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

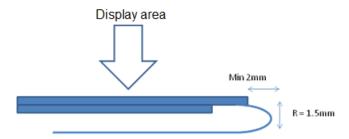
11.2. Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. (We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

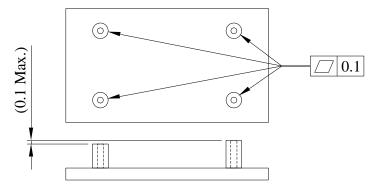
11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
 - * Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.
- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.

- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



(12) The module should be fixed balanced into the housing, or the module may be twisted.



(13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

11.4. Precautions when disposing of the OLED display modules

(1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.